

PCB specification

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Board type:	Rigid	Min track:	127 um
Layer count:	4	Min clearance:	127 um
Quality requirement:	IPC-6012 Class 2	Min PTH:	0.2 mm
Laminate and copper:		Surface finish:	ENIG
Thickness:	1.0 mm	Solder mask:	
PCB size:		Solder mask color:	Blue
X:	18.6 mm	Via hole plug:	
Y:	15 mm	Micro via:	No
Panel size		RoHS compliant	Yes
X:		UL approved	Yes
Y:		Markings	Manufacturer logo, production date and UL and RoHS recognition marks in solder mask
Controlled impedance:	No	Repairs and X-outs:	Not allowed
		Legend print:	Yes
Impedance tollerance:		Legend print color:	White

Comments:

1. Assembled PCB is to be mounted by end customer onto carrier PCB.
2. No solder paste on bottom layer LGA pads and solder pads (SB)